

**Product data sheet** 

### **1. General description**

Planar passivated Silicon Controlled Rectifier with sensitive gate in a TO92 plastic package. This SCR is designed to be interfaced directly to microcontrollers, logic ICs and other low power gate trigger circuits.

## 2. Features and benefits

- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Sensitive gate

## 3. Applications

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- Ignition circuits
- Lighting ballasts
- Protection circuits
- Switched Mode Power Supplies

## 4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Absolute	maximum rating	· · · · · · · · · · · · · · · · · · ·	·				
$V_{RRM}$	repetitive peak reverse voltage			-	-	600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 1</u>		-	-	0.5	A
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	-	0.8	A
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5		-	-	8	A
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		-	-	9	А
Tj	junction temperature			-	-	125	°C
Static cha	racteristics						
I <sub>GT</sub>	gate trigger current	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 10 mA; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		30	-	60	μA
Dynamic	characteristics						
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; R <sub>GK</sub> = 1 kΩ; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 12		500	800	-	V/µs
		$V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; gate open circuit; Fig. 12		-	25	-	V/µs

# 5. Pinning information

Table 2.	Pinning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode		
2	G	gate	]	A H K
3	К	cathode	() (	G sym037

# 6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	Name		method	quantity	version	issue date		
BT169G-M	TO92	BT169G-MQP	Reel	2000	SOT54 wide pitch	14-Nov-2013		

## 7. Marking

Table 4. Marking codes							
	Type number	Marking codes					
	BT169G-M	BT169GM					

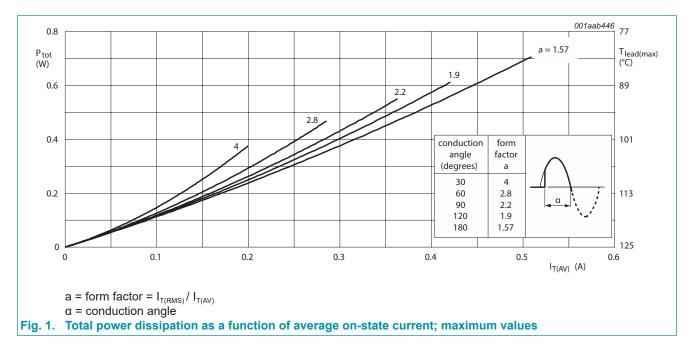
## 8. Limiting values

### Table 5. Limiting values

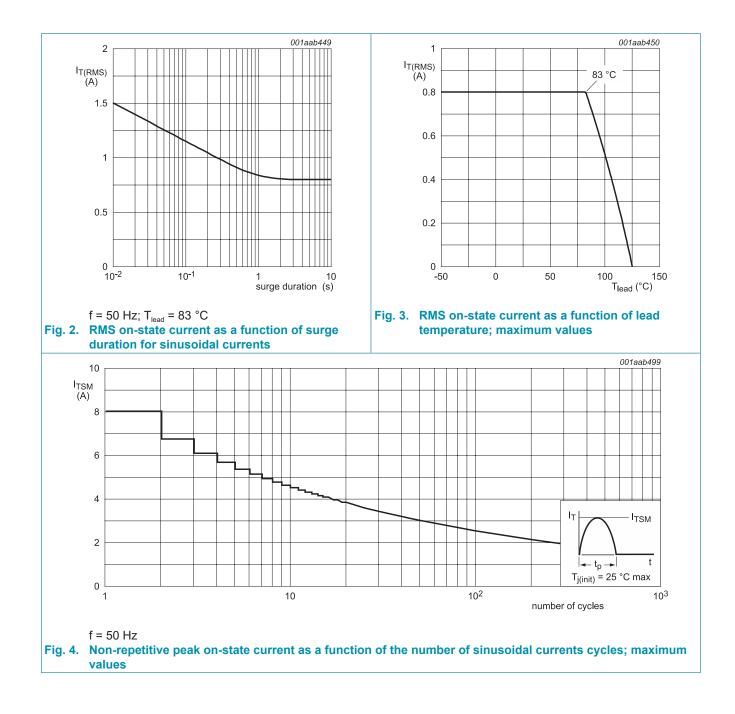
In accordance with the Absolute Maximum Rating System (IEC 60134).

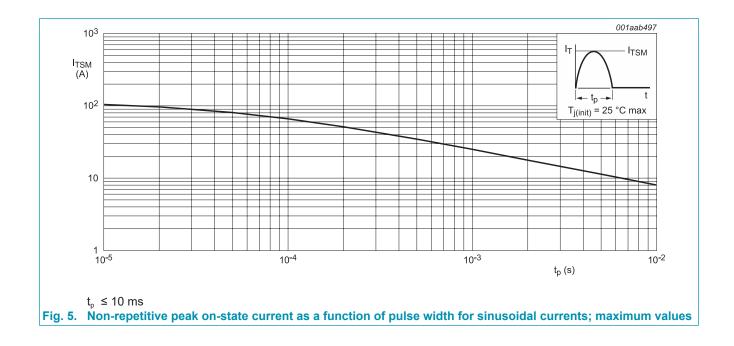
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage			-	600	V
V <sub>RRM</sub>	repetitive peak reverse voltage			-	600	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 1</u>		-	0.5	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; <u>Fig. 2; Fig. 3</u>		-	0.8	А
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig. 4; Fig. 5		-	8	A
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		-	9	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; SIN		-	0.32	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	$I_T = 2 \text{ A}; I_G = 10 \text{ mA}; \text{dI}_G/\text{dt} = 100 \text{ mA}/\mu\text{s}$		-	50	A/µs
I <sub>GM</sub>	peak gate current			-	1	А
$V_{RGM}$	peak reverse gate voltage			-	5	V
P <sub>GM</sub>	peak gate power			-	2	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period		-	0.1	W
T <sub>stg</sub>	storage temperature			-40	150	°C
Tj	junction temperature		[1]	-	125	°C

[1] Operation above 110°C may require the use of a gate to cathode resistor of  $1k\Omega$  or less.



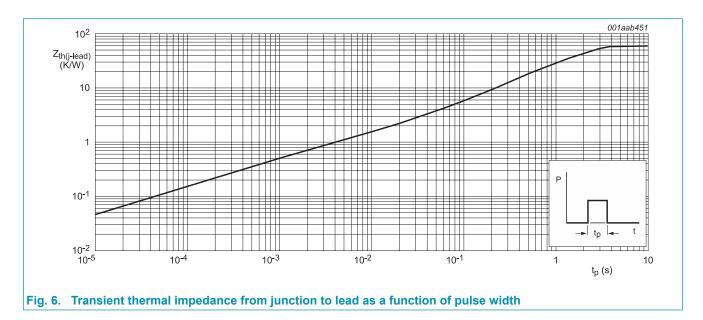
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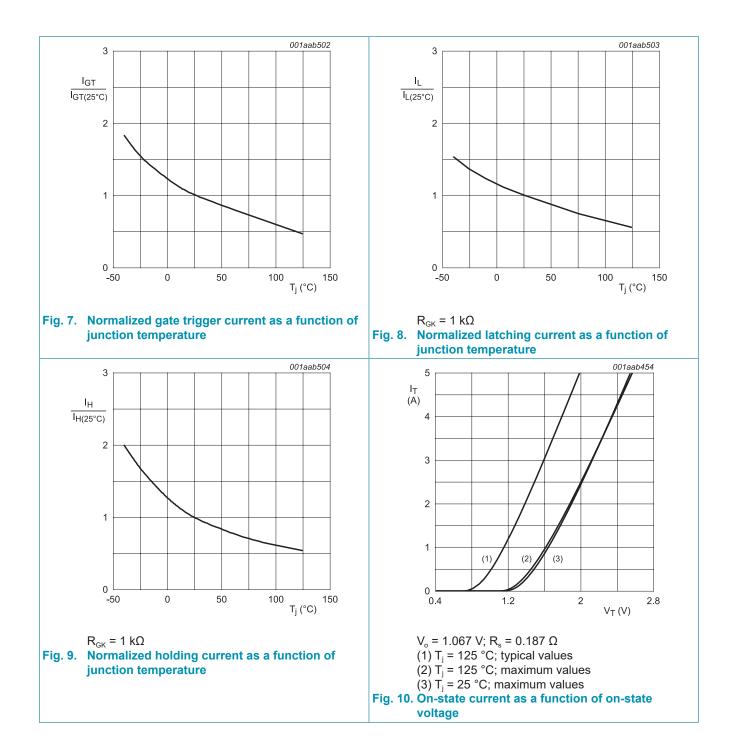
# 9. Thermal characteristics

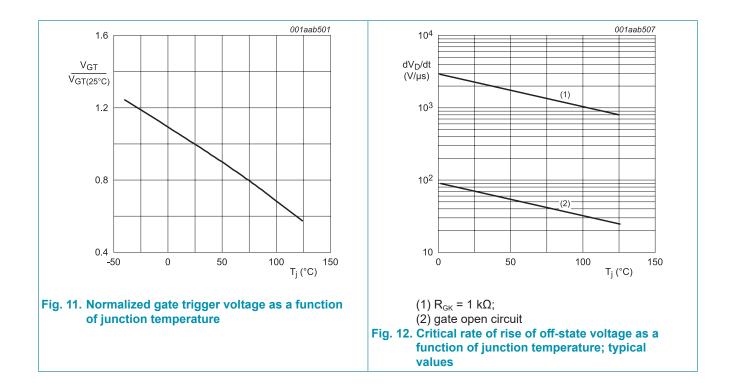
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	<u>Fig. 6</u>	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	printed circuit board mounted: lead length = 4 mm	-	150	-	K/W



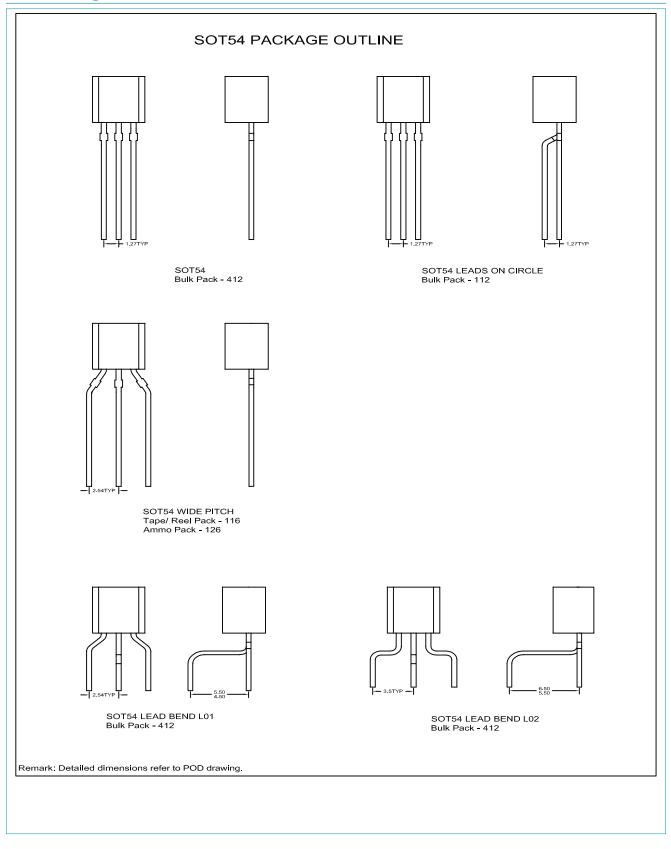
## **10. Characteristics**

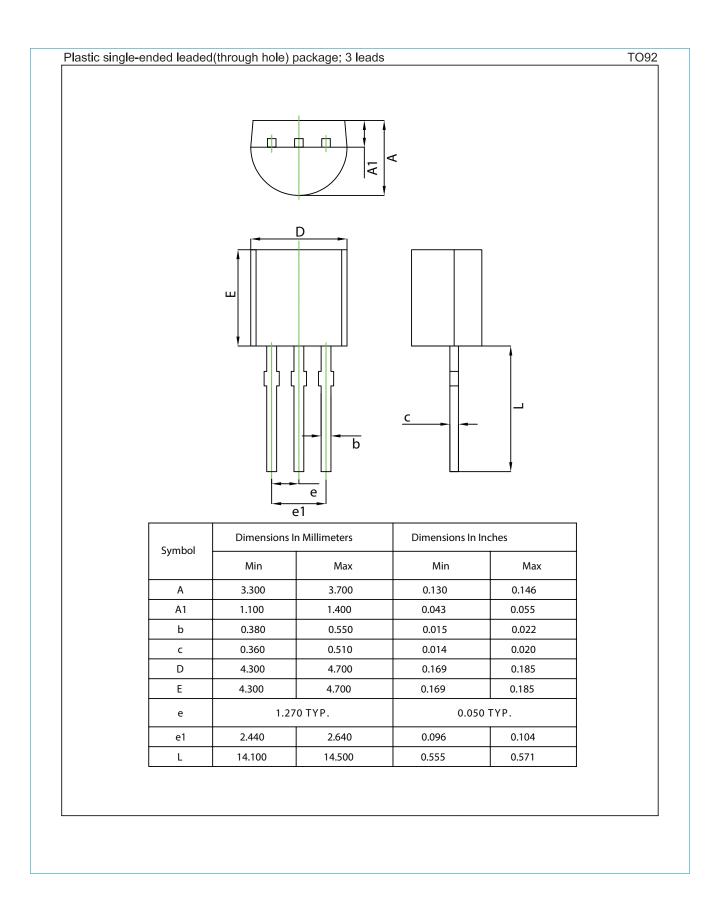
Table 7. Cl	naracteristics						
Symbol	Parameter	Conditions	1	Min	Тур	Max	Unit
Static cha	racteristics		·				
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 10 mA; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>	:	30	-	60	μA
I <sub>L</sub>	latching current	V <sub>D</sub> = 12 V; I <sub>G</sub> = 0.5 mA; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>	-	-	2	6	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>	-	-	2	5	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.2 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	-	1.25	1.7	V
V <sub>GT</sub>	gate trigger voltage	$V_{D}$ = 12 V; I <sub>T</sub> = 10 mA; T <sub>j</sub> = 25 °C; Fig. 11	-	-	0.5	0.8	V
		$V_{\rm D}$ = 600 V; $I_{\rm T}$ = 10 mA; $T_{\rm j}$ = 125 °C	(	0.2	0.3	-	V
I <sub>D</sub>	off-state current	$V_{D} = 600 \text{ V}; \text{ R}_{GK(ext)} = 1 \text{ k}\Omega; \text{ T}_{j} = 125 \text{ °C}$	-	-	0.05	0.1	mA
I <sub>R</sub>	reverse current	$V_{R}$ = 600 V; T <sub>j</sub> = 125 °C; R <sub>GK(ext)</sub> = 1 kΩ	-	-	0.05	0.1	mA
Dynamic	characteristics						
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; R <sub>GK</sub> = 1 kΩ; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; Fig. 12	Į	500	800	-	V/µs
		$V_{DM}$ = 402 V; T <sub>j</sub> = 125 °C; (V <sub>DM</sub> = 67% of V <sub>DRM</sub> ); exponential waveform; gate open circuit; Fig. 12	-	-	25	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 2 \text{ A};  V_{D} = 600 \text{ V};  I_{G} = 10 \text{ mA};  dI_{G} \text{/} \\  dt = 0.1  A \text{/} \mu \text{s};  T_{j} = 25 ^{\circ} \text{C}$	-	-	2	-	μs
t <sub>q</sub>	commutated turn-off time			-	100	-	μs





# 11. Package outline





### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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**BT169G-M** 

SCR

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